

NOTES: 1. GOLD PLATE 100~225 μ INCHES OVER
100~250 μ INCHES NICKEL.
2. B/G PAD "A", "B" AND LEAD NO.32
TO BE ELECTRICALLY CONNECTED
TO THE DIE ATTACH PAD.
SEAL RING ISOLATED.
3. LEAD RESISTANCE : 350 m Ω MAX

発行
97.9.24
技術部
製品課

| | | | | | |
|--|---------|---------------|---------------------|---------------|-------------------------|
| 3 | | | | | |
| 2 | | | | | |
| 1 | CERAMIC | BLACK ALUMINA | | NEW DRAWING | AUG-28-1997 |
| Item | No. & # | Material | Description | Rev. | Description |
| UNLESS OTHERWISE SPECIFIED TOLERANCES: 1. 1X | | | DRAWN T. miwq | | NTK TECHNICAL CERAMICS |
| N. L. T. 2 DECIMALS .XX \pm .01 | | | CHECKED H. NAKAMURA | | NGK SPARK PLUG CO., LTD |
| 3 DECIMALS .XXX \pm .005 | | | APPROVED J. WASHINO | | TITLE |
| CUSTOMER | | | | | 32 LEAD CHIP CARRIER H |
| DWG # | | | UNIT INCH | DWG NO. | SIZE A-2 (C) |
| | | | SCALE | IRK32F1-6154A | |

MODIFIED DWG NO. IRK32F1-5988A

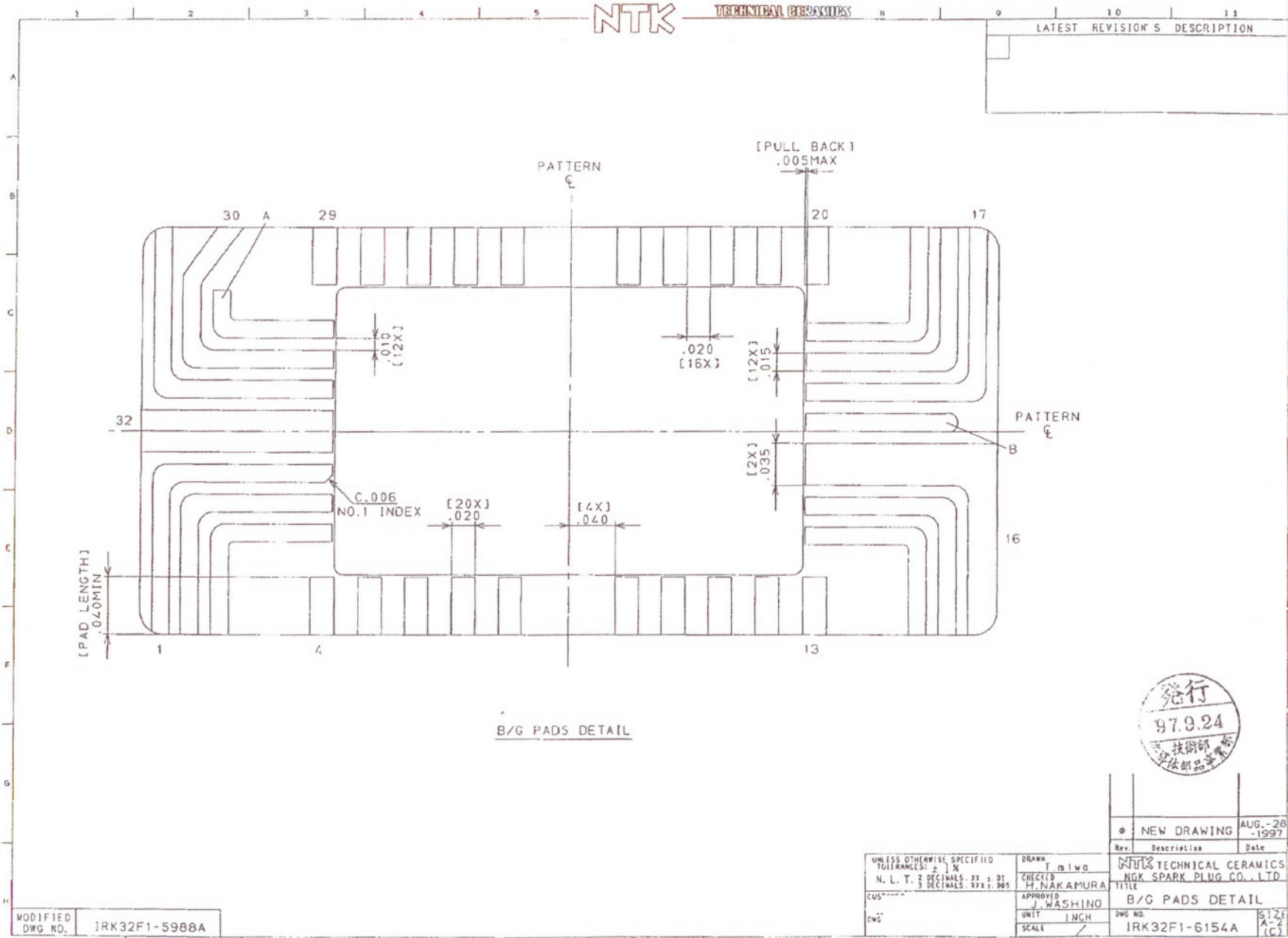
PART NO. SHEET 1 OF 2 M-H



NTK

TECHNICAL CERAMICS

LATEST REVISIONS DESCRIPTION



B/G PADS DETAIL

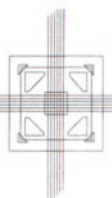
発行
97.9.24
技術部

| | | |
|---|---------------|--------------------|
| Rev. | Description | Date |
| 0 | NEW DRAWING | AUG.-28-1997 |
| NTK TECHNICAL CERAMICS IRK SPARK PLUG CO., LTD | | |
| TITLE B/G PADS DETAIL | | |
| DWG NO. | IRK32F1-6154A | SIZE A-2 (C) |

MODIFIED DWG NO. 1RK32F1-5988A

| | |
|---|---------------------|
| UNLESS OTHERWISE SPECIFIED TOLERANCES: ± .01 MM | DRAWN T. miwo |
| N. L. T. 2 DECIMALS. 25 ± .01 | CHECKED H. NAKAMURA |
| CUS. 3 DECIMALS. 30 ± .01 | APPROVED J. WASHINO |
| DWG | UNIT INCH |
| | SCALE |

PART NO. SHEET 2 OF 2 M



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